

IN THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

1-25. (Canceled)

26. (Currently Amended) An apparatus for manufacturing photomask blanks comprising:
a sputtering chamber, wherein only one substrate at a time is introduced therein for forming a
film on said substrate;

a load lock chamber for receiving said only one substrate at a time and placing said only one
substrate on standby prior to introduction to said sputtering chamber, wherein said load lock chamber
is able to ~~draw a vacuum to~~ reach a predetermined chamber pressure degree of vacuum each time
before said substrate is introduced into said sputtering chamber;

an unload lock chamber for placing said substrate upon exit from said sputtering chamber;
and

a substrate conveying means for introducing a substrate one by one continuously at a constant
interval from said load lock chamber to said sputtering chamber, and from said sputtering chamber to
said unload lock chamber.

27. (Currently Amended) An apparatus for manufacturing photomask blanks comprising:
a substrate holder for holding a square shaped substrate, said holder having a rotation
mechanism for rotating the substrate around its center axis; and
a target placed in an opposed position with a center axis of said target deviating from [[a]]
the center axis of said substrate held by said substrate holder.

28. (Previously presented) An apparatus according to claim 27, wherein the target is placed so that the opposed surfaces of the target and the substrate form a predetermined angle therebetween.

29. (Currently amended) An apparatus according to claim 27, further comprising:
means for detecting a rotation position of the substrate; and
means for turning OFF ~~the an~~ electric discharge to finish film formation when the substrate has completed an integral number of rotatations from the position when turning ON the electric discharge to start film formation, so as to finish film formation at the position of the same rotation angle as the starting position of the film formation.